

In re Application of:
Wai-Fan Yau, et al.

Serial No.: 10/756,122

Confirmation No.: 4554

Filed: January 13, 2004

**For: A Low Dielectric Constant
Film Produced from Silicon
Compounds Comprising
Silicon-Carbon Bond**

Group Art Unit: 2823

Examiner: Julio J. Maldonado

MAIL STOP AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of Examiner Julio J. Maldonado, on the date shown below.

10/23/07

Keith M. Tackett

Dear Sir:

RESPONSE TO FINAL OFFICE ACTION DATED SEPTEMBER 25, 2007

In response to the Final Office Action dated September 25, 2007, having a shortened statutory period for response set to expire on December 25, 2007, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/002592.C7/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 4 of this paper.